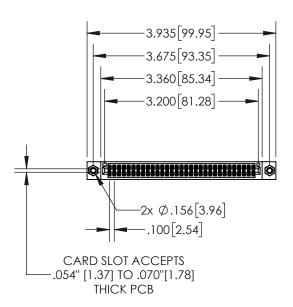
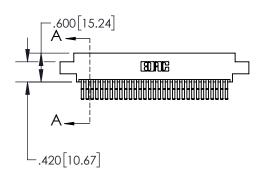
Contact Dimensions:

560-Extender Board Bend (Code 523 Contacts) See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

1







.330[8.38] **CARD SLOT ⊸**.370[9.40] **SECTION A-A** .160 4.06 POINT OF CONTACT **-**.200 [5.08]

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 \$	SERIES HIGH TEMP	CARD ED	DGE CONNE	CTOR
PART NUM	MBFR: 845-062-56	808-08		

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER				
DRAWN: R.STA.MONICA	DATE:MAY.16/2017			
CHECKED:	DATE:			
SCALE: 1:2	SHEET 1 OF 2			
DRAWING NUMBER	ISSUE			

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

Contact Code 558

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

Contact Code 559

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

Contact Code 560

845-ENG-MASTER